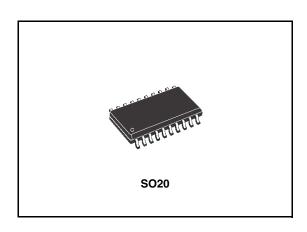


0.5A high-side driver industrial intelligent power switch

Features

- 0.5A output current
- 8V to 35V supply voltage range
- Internal current limiting
- Thermal shutdown
- Open ground protection
- Internal negative voltage clamping for fast demagnetization
- Differential inputs with large common mode range and threshold hysteresis
- Undervoltage lockout with hysteresis
- Open load detection
- Two diagnostic outputs
- Output status LED driver
- Non dissipative short circuit protection
- Immunity against burst transient (IEC 61000-4-4)
- ESD protection (human body model ±2kV)



Description

The L6375D is a monolithic Intelligent Power Switch in Multipower BCD Technology, for driving inductive or resistive loads with controlled output voltage slew rate and short circuit protection.

An internal Clamping Diode enables the fast demagnetization of inductive loads. Diagnostic for CPU feedback and extensive use of electrical protections make this device extremely rugged and specially suitable for industrial automation applications.

Table 1. Device summary

Order codes	er codes Op. temp. range, °C Package		Packaging
L6375D	-25 to +125	SO20	Tube
L6375DTR	-25 to +125	SO20	Tape & Reel

July 2007 Rev 1 1/16

Contents L6375D

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1 Block diagram and pin description

Block diagram Figure 1. UNDER CHARGE PUMP VOLTAGE IN+ DRIVER OUT CURRENT LIMITATION NON DISSIPATIVE SHORT CIRCUIT OPEN LOAD DETECTION osc ON- DELAY OUTSTATUS DIAG1 DIAGNOSTIC THERMAL PROTECTION DIAG2 **√** 3mA OUTPUT STATUS

N.C. ■ N.C. 20 GND \square 19 ON DELAY N.C. 3 18 ■ N.C. OUTPUT \square 17 SO20 N.C. 🔲 5 16 ■ N.C. V_S □ 15 DIAG1 DIAG2 N.C. 🔲 7 14 N.C. 🔲 8 ■ N.C. 13 N.C. 12 N.C. OUTPUT STATUS

11

■ N.C.

10

Figure 2. Pin connection (top view)

1.1 Pin description

Table 2. Pin description

	i iii decemption		
Pin N°	Pin name	Function	
2	GND	Ground	
4	OUT	High Side output with built-in current limitation	
6	V _S	Supply Voltage Input, the value of the supply voltage is monitored to detect under voltage condition	
10	Output status	This current source output is capable of driving a LED to signal the status of the output pin. The pin is active (source current) when the output pin is considered high (See <i>Figure 4</i>)	
15	DIAG1	DIAGNOSTIC 1 output. This open drain reports the IC working conditions. (See Diagnostic truth <i>Table 7</i>)	
14	DIAG2	DIAGNOSTIC 2 output. This open drain reports the IC working conditions. (See Diagnostic truth <i>Table 7</i>)	
17	IN+	Comparator inverting input	
19	ON-DELAY	Programmable ON time interval duration during short circuit operation	
1, 3, 5, 7, 8, 9, 11, 12, 13, 16, 18, 20	N.C.	Not connected	

2 Electrical specifications

2.1 Absolute maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vs	Supply voltage (tw < 10 ms)	50	V
Vs	Supply voltage (DC)	40	V
Vs -Vout	Supply to output differential voltage	internally limited	V
Vod	Externally forced voltage	-0.3 to 7	V
lod	Externally forced current	±1	mA
lout	Output current (see also Isc)	internally limited	Α
Vout	Output voltage	internally limited	V
P _{TOT}	Power dissipation	internally limited	W
Vdiag	External voltage	-0.3 to 40	V
Idiag	Externally forced current	-10 to 10	mA
li	Input current	20	mA
Vi	Input voltage	-10 to Vs +0.3	V
Тор	Ambient temperature, operating range	-25 to 85	°C
T _J	Junction temperature, operating range (see Overtemperature Protection)	-25 to 125	°C
Тѕтс	Storage temperature	-55 to 150	°C
E _I	Energy inductive load T _J = 85°C	200	mJ

2.2 Thermal data

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R _{thJA}	Thermal resistance Junction-ambient Max (1)	65	°C/W
R _{thJP}	Thermal resistance Junction-pins Max	15	°C/W

^{1.} When mounted on a FR4 printed circuit board with 0.5 cm2 of Cu (at least 35mm thick)

2.3 Electrical characteristics

Table 5. Electrical characteristics $(V_S = 24V; T_J = -25 \text{ to } +125^{\circ}\text{C}, \text{ unless otherwise specified})$

Symbol	Parameter	Test condition	Min	Тур	Max	Unit
V _{smin}	Supply voltage for valid diagnostic	Idiag = > 0.5mA; Vdiag = 1.5V;	4		35	V
Vs	Operative supply voltage		8	24	35	V
V _{sth1}	Undervoltage threshold 1		7	7.5	8	V
V _{sth2}	Undervoltage threshold 2		6.5	7	7.5	٧
V _{shys}	Under voltage hysteresis		300	500	700	mV
Iq	Quiescent current	Output open		800		μА
I _{qo}	Quiescent current	Output ON		1.6		mA
V _{ith}	Input threshold voltage		0.8	1.3	2	٧
V _{iths}	Input threshold hysteresis		50		400	mV
V _{il}	Input low level voltage		-7		0.8	٧
V _{ih}	Input high level voltage	V _S < 18V	2		V _s - 3	٧
V _{ih}	Input high level voltage	V _s > 18V	2		15	V
I _{ib}	Input bias current	V _i = -7 to 15V	-250		250	mA
I _{dch}	Delay capacitor charging current	ON DELAY pin shorted to Ground		2.5		mA
V _{don}	Output voltage drop	$\begin{aligned} & \text{lout} = 500 \text{mA T}_{\text{J}} = 25^{\circ}\text{C} \\ & \text{T}_{\text{J}} = 125^{\circ}\text{C} \\ & \text{lout} = 625 \text{mA T}_{\text{J}} = 25^{\circ}\text{C} \\ & \text{T}_{\text{J}} = 125^{\circ}\text{C} \end{aligned}$		200 320 250 400	280 440 350 550	mV mV mV
l _{olk}	Output leakage current	V _i = LOW; Vout=0			100	μА
V _{ol}	Output low state voltage	V _i = HIGH; pin floating		0.8	1.5	٧
V _{cl}	Internal voltage clamp (Vs-Vout)	I _o = 200mA single pulsed = 300ms	48	53	58	V
I _{sc}	Short circuit output current	$V_s = 8 \text{ to } 35V; R_l = 2\Omega;$	0.75	1.1	1.5	Α
I _{old}	Open load detection current	$V_i = V_{ih}; T_A = 0 \text{ to } +85^{\circ}\text{C}$	1	3	6	mA
V _{oth1}	Output status threshold 1 voltage		4.5	5	5.5	٧
V _{oth2}	Output status threshold 2 voltage		4	4.5	5	V
V _{ohys}	Output status threshold hysteresis		300	500	700	mV
I _{osd}	Output status source current	Vout > Voth1; Vos = 2.5V	2		4	mA

Table 6. Electrical characteristics $(V_S = 24V; T_J = -25 \text{ to } +125^{\circ}\text{C}, \text{ unless otherwise specified})$

Symbol	Parameter	Test condition	Min	Тур	Max	Unit
V _{osd}	Active output status driver drop voltage	V _S - V _{OS} ; I _{OS} = 2mA T _A = 0 to +85°C		1.5	3	V
I _{oslk}	Output status driver leakage current	V _{out} < V _{oth2} ; V _{os} = 0V V _S = 18 to 35V			25	mA
V_{dgl}	Diagnostic drop voltage	D1 / D2 = L ; I _{diag} = 0.5mA D1 / D2 = L ; I _{diag} = 3mA		40 250		mV mV
İdgik	Diagnostic leakage current	D1 / D2 = H ; 0 < V _{dg} < V _s V _S = 15.6 to 35V			5	μА
T _{max}	Over temperature upper threshold			150		°C
T _{hys}	Over temperature hysteresis			20		°C
AC opera	AC operation (pin numbering referred to Minidip package)					
t _r -t _r	Rise or fall time	$V_s = 24V$; $R_l = 70\Omega R_l$ to ground		20		μS
t _d	Delay time	$V_s = 24V$; $R_l = 70\Omega R_l$ to ground		5		μS
dV/dt	Slew rate (rise and fall edge)		7	1	15	V/μs
t _{ON}	On time during short circuit condition	50pF < C _{DON} < 2nF		1.28		μs/pF
t _{OFF}	Off time during short circuit condition			64		t _{ON}
f _{max}	Maximum operating frequency			25		KHz
Source o	Source drain NDMOS diode					
V _f	Forward on voltage	@ Ifsd = 625mA		1	1.5	V
I _{fD}	Forward peak voltage	t = 10ms; d = 20%			2	Α
t _{rr}	Reverse recovery time	If= 625mA di/dt = 25A/ms		200		ns
t _{fr}	Forward recovery time			50		ns

2.4 Switching waveform

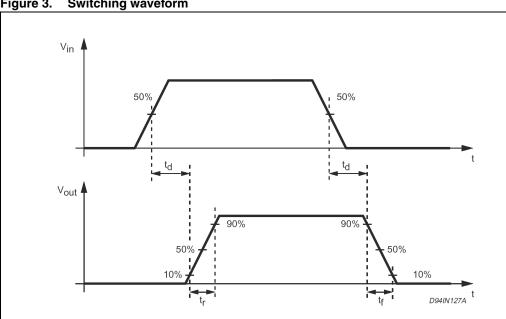


Figure 3. Switching waveform

2.5 Input section

An Single ended Input TTL/CMOS compatible with wide voltage range and high noise immunity (thanks to a built in hysteresis) is available.

2.6 Over temperature protection (OVT)

An on-chip Over Temperature Protection provides an excellent protection of the device in extreme conditions. Whenever the temperature - measured on a central portion of the chip exceeds T_{max} = 150°C (typical value) the device is shut off, and the DIAG2 output goes LOW. Normal operation is resumed as the chip temperature (normally after few seconds) falls below T_{max} - T_{hys} = 130°C (typical value). The hysteresis avoid thats an intermittent behaviour take place.

2.7 Under voltage protection (UV)

The supply voltage is expected to range from 8 to 35V. In this range the device operates correctly. To avoid any misfunctioning the supply voltage is continuously monitored to provide an under voltage protection. As V_s falls below V_{sth}-V_{shvs} (typically 7.5 V, see fig.1) the output power MOS is switched off and DIAG1 and DIAG2 (see Diagnostic truth table). Normal operation is resumed as soon as Vs exceeds Vsth. The hysteretic behaviour prevents intermittent operation at low supply voltage.

2.8 Over current operation

In order to implement a short circuit protection the output power MOS is driven in linear mode to limit the output current to the I_{sc} (1.1A typical value). This condition (current limited to the lsc value) lasts for a Ton time interval, that can be set by means of a capacitor (C_{don}) connected to the ON DELAY pin according to the following formula:

$$T_{on} = 1.28 \,\mu sec/pF$$

for

$$50pF < C_{don} < 2nF$$

After the T_{on} interval has expired the output power MOS is switched off for the T_{off} time interval with:

$$T_{off} = 64 \cdot T_{on}$$

When also the Toff interval has expired, the out-put power MOS is switched ON. At this point in time two conditions may occur

- The overloadis still present, and then the output power MOS is again driven in linear mode (limiting the output current to I_{SC}) for another T_{ON}, starting a new cycle. or
- the over load the overload condition is removed, and the output power MOS is no longer driven in linear mode. All these occurrences are presented on the DIAG2 pin (see fig 2).

We call this unique feature Non Dissipative Short Circuit Protection and it ensures a very safe operation even in permanent overload conditions. Note that choosing the most appropriate value for the Ton interval (i.e. the value of the Cdon capacitor) a delay (the Ton itself) will prevent that a misleading Short Circuit information is presented on the DIAG2 output, when driving capacitive loads (that acts like short circuit in the very beginning)

or Incandescent Lamp (a cold filament has a very low resistive value). The Non Dissipative Short Circuit Protection can be disabled (keeping Ton = 0 but with the output current still limited to Isc, and Diagnostic disabled) simply shorting to ground the the ON DELAY pin.

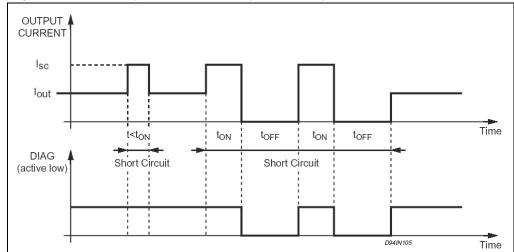


Figure 4. Non dissipative short circuit protection operation

2.9 Diagnostic logic

The operating conditions of the device are permanently monitored and the following occurrences are signalled via the DIAG1/DIAG2 open-drain output pins see diagnostic Truth Table.

- Short Circuit versus ground.
- Short Circuit versus VS.
- Under Voltage(UV)
- Over Temperature (OVT)
- Open Load, if the output current is less than 3mA (typical value).

2.10 Demagnetization of inductive loads

An internal zener diode, limiting the voltage across the Power MOS to between 50 and 60V (VcI), provides safe and fast demagnetization of inductive loads without external clamping devices. The maximum energy that can be absorbed from an inductive load is specified as 200mJ (at $T_J = 85^{\circ}$ C)

2.11 Diagnostic truth table

Table 7. Diagnostic truth table

Diagnostic conditions	Input	Output	Diag1	Diag2
Normal Operation	L	L	Н	Н
Normal Operation	Н	Н	Н	Н
Open Load Condition (L. L.)	L	L	Н	Н
Open Load Condition (I _o < I _{old})	Н	Н	L	Н
Chart to V	L	Н	L	Н
Short to V _S	Н	Н	L	Н
Short Circuit to Ground (I _O = I _{SC}) ⁽¹⁾	Н	Х	Н	Н
(pin ON-DELAY grounded)	L	L	Н	Н
Output DMOS Open	L	L	Н	Н
Output DMOS Open	Н	L	L	Н
Overtemperature	L	L	Н	L
Overtemperature	Н	L	Н	L
Supply Undervoltage (V x V)	L	L	L	L
Supply Undervoltage (V _S < V _{sth2})	Н	L	L	L

A cold lamp filament, or a capacitive load may activate the current limiting circuit of the IPS, when the IPS
is initially turned on.

L6375D Application circuits

3 Application circuits

Figure 5. Inductive load equivalent circuit

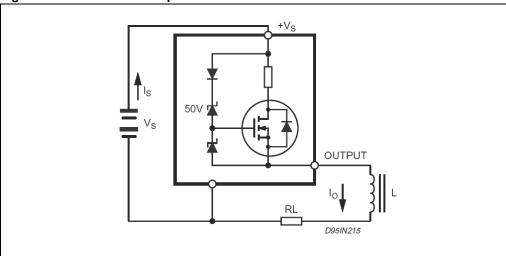
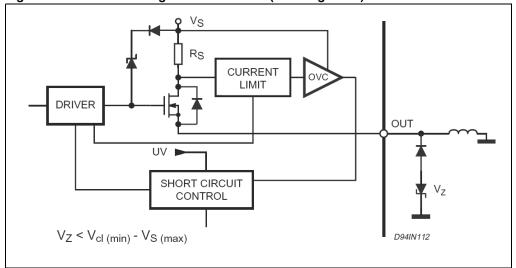


Figure 6. External demagnetisation circuit (versus ground)



Application circuits L6375D

Figure 7. External demagnetisation circuit (versus vs)

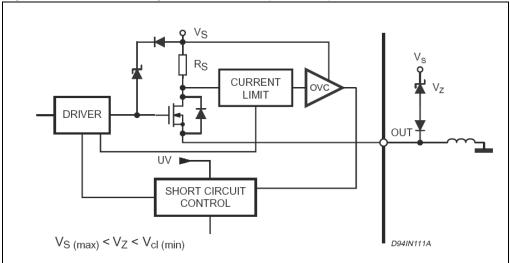
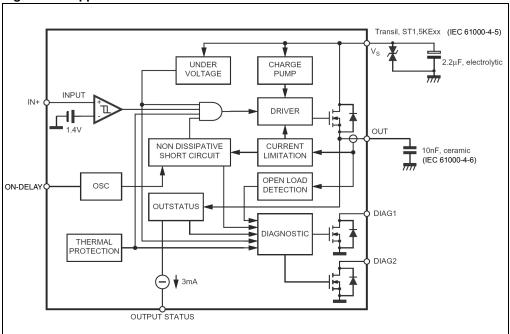


Figure 8. Application schematic



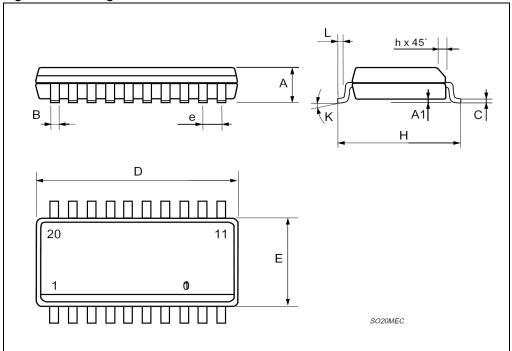
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Table 8. SO20 mechanical data

Dim		mm				
Dim.	Min	Тур	Max	Min	Тур	Max
Α	2.35		2.65	0.093		0.104
A1	0.1		0.3	0.004		0.012
В	0.33		0.51	0.013		0.020
С	0.23		0.32	0.009		0.013
D	12.6		13	0.496		0.512
E	7.4		7.6	0.291		0.299
е		1.27			0.050	
Н	10		10.65	0.394		0.419
h	0.25		0.75	0.010		0.030
L	0.4		1.27	0.016		0.050
K			0° (min.)	8° (max.)		•

Figure 9. Package dimensions



L6375D Revision history

5 Revision history

Table 9. Revision history

Date	Revision	Changes
24-Jul-2007	1	Initial release

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